



D36V0S1U2LP1610Q

ONE CHANNEL HIGH SURGE TVS DIODE

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The D36V0S1U2LP1610Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: U-DFN1610-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.003 grams (Approximate)

U-DFN1610-2 (Type B)



Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D36V0S1U2LP1610Q-7	Automotive	36T	7	8	10,000/Tape & Reel

Notes:

- $1.\ No\ purposely\ added\ lead.\ Fully\ EU\ Directive\ 2002/95/EC\ (RoHS),\ 2011/65/EU\ (RoHS\ 2)\ \&\ 2015/863/EU\ (RoHS\ 3)\ compliant.$
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Option A:



36T = Product Type Marking Code YM = Date Code Marking Y = Year (ex: I = 2021) M = Month (ex: 9 = September) Dot Denotes Cathode Side

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I	J	K	L	М	N	0	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Option B:



36T = Product Type Marking Code YWX = Date Code Y = Year Code: 0 to 9

W = Week Code: A to Z Represents Week 1 to 26; a to z Represents Week 27 to 53; z Represents Week 52 and 53

X = Internal Code

Dot Denotes Cathode Side

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	Ú	V	W	X	Υ	Z



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_AIR}	±30	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)		PD	300	mW
Thermal Resistance, Junction to Ambient	$T_A = +25^{\circ}C$	Reja	417	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Part Number	Reverse Standoff Voltage	Breakdown Voltage		Test Current	Max. Reverse Leakage Current @ V _{RWM} (Note 6)	Max. Clamping Voltage @ Ipp (Note 7)	Max. Peak Pulse Current	Channel Input Capacitance (Note 8) VR = 0V, f = 1MHz,	Marking Code
		V _{BR}	@ IT		(222 2)			Any I/O to GND	
	V _{RWM} (V)	Min (V)	Max (V)	I _T (mA)	I _R (nA)	Vc (V)	IPP (A)	(pF)	
D36V0S1U2LP1610Q-7	36	37	44	1	200	59	18	165	36T

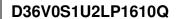
Notes:

^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

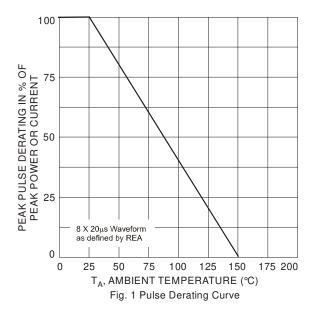
6. Short duration pulse test used to minimize self-heating effect.

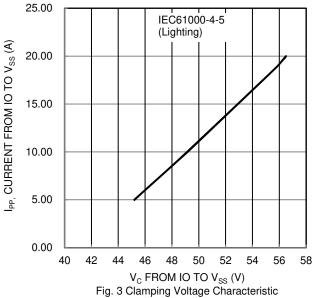
^{7.} Clamping voltage value is based on an $8x20\mu s$ peak pulse current (I_{PP}) waveform.

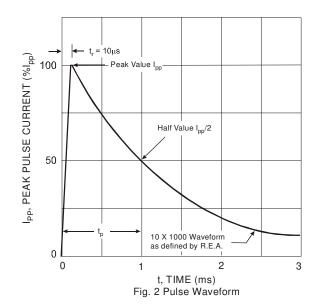
^{8.} Measured from any I/O to GND.

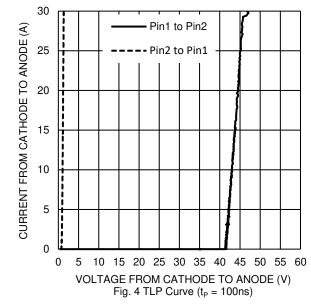










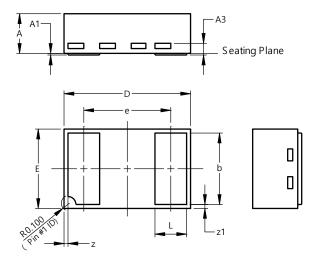




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1610-2 (Type B)

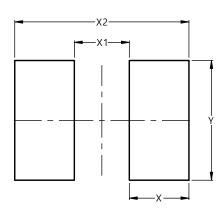


U-DFN1610-2 (Type B)									
Dim	Min	Min Max Typ							
Α	0.45	0.55	0.50						
A1	0.00	0.05	0.015						
A3	1	0.12							
b	0.85	0.95	0.90						
D	1.55	1.65	1.60						
Е	0.95	1.05	1.00						
е	-	-	1.10						
L	0.35	0.45	0.40						
Z	0.050 REF								
z 1	1 0.050 REF								
All C	imens	ions in	mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1610-2 (Type B)



Dimensions	Value (in mm)
Х	0.650
X1	0.600
X2	1.900
Υ	1.300



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